# Surface Mount **Schottky Power Rectifier**

## **SMB Power Surface Mount Package**

This device employs the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

### Features

- Compact Package with J–Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over–Voltage Protection
- Low Forward Voltage Drop
- Pb-Free Package is Available

### **Mechanical Characteristics:**

- Case: Molded Epoxy
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 95 mg (Approximately)
- Cathode Polarity Band
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C$ = 110°C)	Ι <sub>Ο</sub>	1.0	A
Peak Repetitive Forward Current (At Rated $V_R$ , Square Wave, 100 kHz, $T_C = 110^{\circ}C$ )	I <sub>FRM</sub>	2.0	A
Non–Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Storage / Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	10,000	V/μs

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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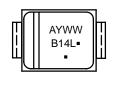
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### SCHOTTKY BARRIER RECTIFIER 1.0 AMPERE – 40 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



B14L = Specific Device Code А

- = Assembly Location
- γ = Year

WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBRS140LT3	SMB	2500/Tape & Reel
MBRS140LT3G	SMB (Pb–Free)	2500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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### THERMAL CHARACTERISTICS

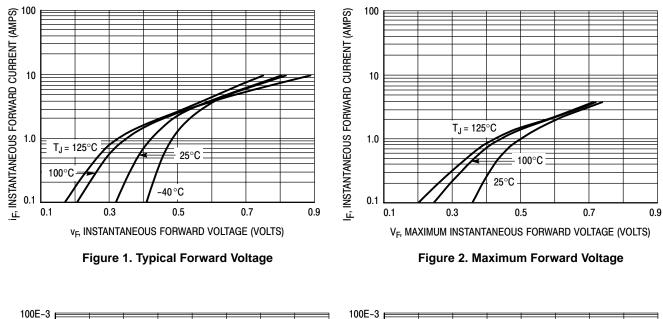
Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction-to-Lead (Note 1)	$R_{\theta JL}$	24	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)		80	°C/W

Mounted with minimum recommended pad size, PC Board FR4.
1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.

### **ELECTRICAL CHARACTERISTICS**

Characteristic		Symbol	$T_J = 25^{\circ}C$	T <sub>J</sub> = 125°C	Unit
Maximum Instantaneous Forward Voltage (Note 3)	(i – 1 0 A)	٧ <sub>F</sub>	0.5 0.6	0.425 0.58	V
see Figure 2	(i <sub>F</sub> = 1.0 A) (i <sub>F</sub> = 2.0 A)		0.0	0.00	
Maximum Instantaneous Devenes Overset (Nate 2)			T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	
Maximum Instantaneous Reverse Current (Note 3)	(V <sub>R</sub> = 40 V)	I <sub>R</sub>	0.4	10	mA
see Figure 4	(V <sub>R</sub> = 40 V) (V <sub>R</sub> = 20 V)		0.02	5.0	

3. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2.0%.



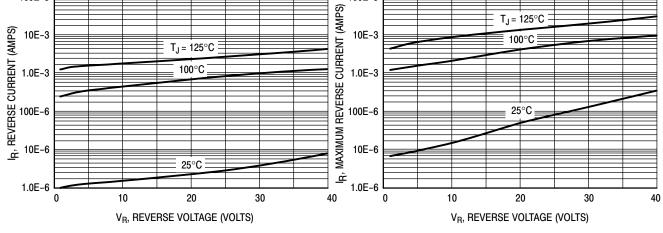
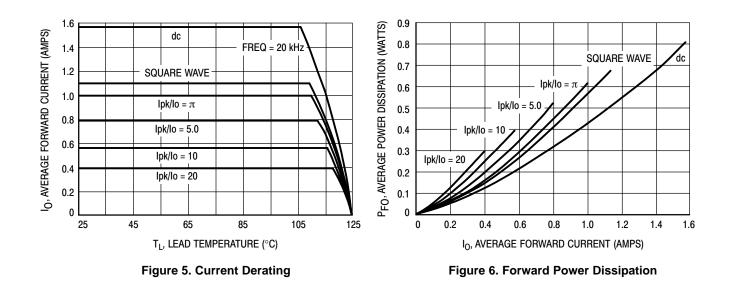
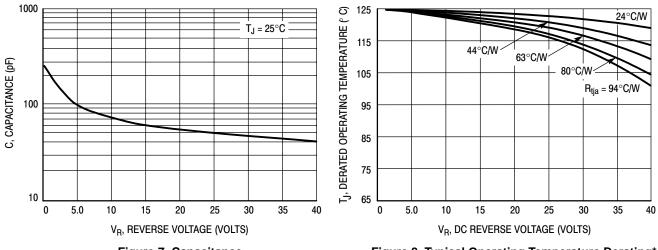


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current







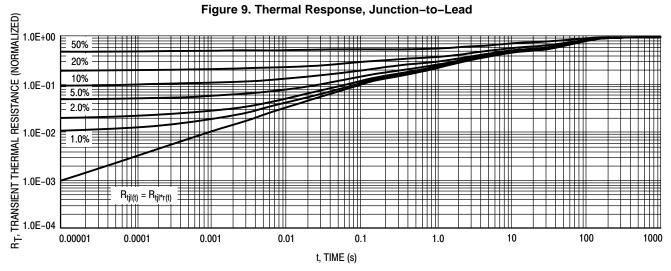


\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of T<sub>J</sub> therefore must include forward and reverse power effects. The allowable operating T<sub>.1</sub> may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

r(t) = thermal impedance under given conditions, Pf = forward power dissipation, and

Pr = reverse power dissipation This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.  $R_{T}$ , TRANSIENT THERMAL RESISTANCE (NORMALIZED) 1.0E+00 50% 20% HH 10% 1.0E-01 5.0% H 2.0% 1.0E-02 1.0% 1.0E-03  $R_{tjl(t)} = R_{tjl*r(t)}$ Ш 1.0E-04 0.00001 0.0001 0.001 0.01 10 100 1000 0.1 1.0



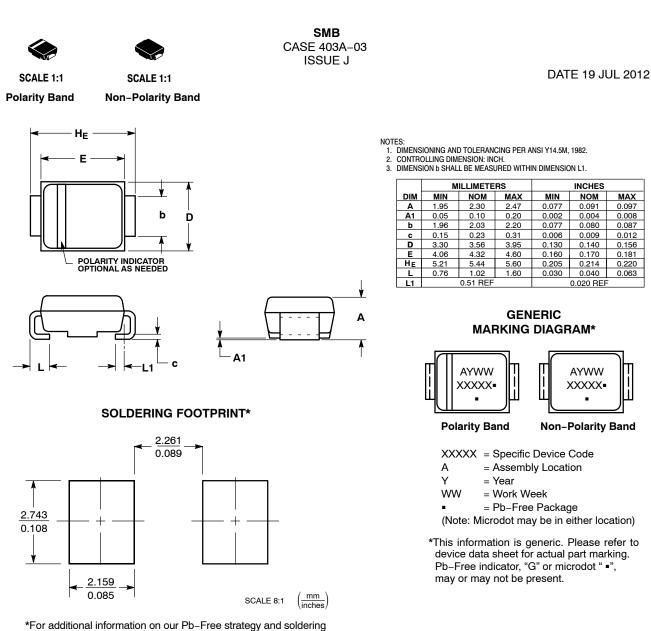




#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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